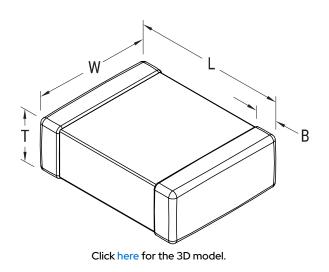




CBR-SMD RF COG, Ceramic, 7.3 pF, +/-0.5 pF, 200 VDC, COG, SMD, Fixed, RF, Ultra High Q, Low ESR, Class I, 0402



General Information	
Series	CBR-SMD RF COG
Style	SMD Chip
Description	SMD, Fixed, RF, Ultra High Q, Low ESR, Class I
Features	Ultra High Q, Low ESR, Class I
RoHS	Yes
Termination	Tin
Marking	No
AEC-Q200	No
Typical Component Weight	1.37 mg
Notes	Solder Reflow Only.
Shelf Life	78 Weeks
MSL	1

Dimensions	
Chip Size	0402
L	1mm +/-0.05mm
W	0.5mm +/-0.05mm
Т	0.5mm +/-0.05mm
В	0.25mm +0.05/-0.1mm

02	Capacitance	7.3 pF
m +/-0.05mm	Tolerance	+/-0.5 pF
mm +/-0.05mm	Voltage DC	200 VDC
mm +/-0.05mm	Dielectric Withstanding Voltage	500 VDC
5mm +0.05/-0.1mm	Temperature Range	-55/+125°C
	Temp. Coefficient	COG
	Aging Rate	0% Loss/Decade Hour
R, 180mm, Plastic Tape	Insulation Resistance	10 GOhms
	Quality Factor	546

Specifications

Packaging Specifications	
Packaging	T&R, 180mm, Plastic Tape
Packaging Quantity	10000

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - and we specifically disclaim - any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.

Generated 07/25/2025 © 2006 - 2025 YAGEO